

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT4216814

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MARTIN FOLTIN	10/29/2014
YOOCHARN JEON	10/30/2014
BRENT BUCHANAN	10/30/2014
ERIK ORDENTLICH	10/29/2014
NAVEEN MURALIMANO HAR	10/30/2014
JAMES S. IGNOWSKI	10/30/2014
JACQUELYN M. INGEMI	10/30/2014
RECEIVING PARTY DATA	
Name:	Hewlett-Packard Development Company, L.P.
Street Address:	11445 Compaq Center Drive West
City:	Houston
State/Country:	TEXAS
Postal Code:	77070
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15325040
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	JOANNA KEYT
SIGNATURE:	/Joanna Keyt/
DATE SIGNED:	01/09/2017

Total Attachments: 12

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HEWLETT-PACKARD COMPANY
Intellectual Property Administrator
3404 E. Harmony Road
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PATENT APPLICATION

RECORD ID: 84033033

ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each), for good and valuable consideration, the receipt of which is hereby acknowledged, and in furtherance of my/our obligations to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter HPDC), and to its subsidiaries and affiliates, agree to assign and transfer and hereby assign and transfer to HPDC, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Patent entitled:

SENSING CIRCUIT FOR RESISTIVE MEMORY

Filing Date: Application No.:

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Patent, and any and all other Patent of any countries thereto which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Patent.

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Date

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